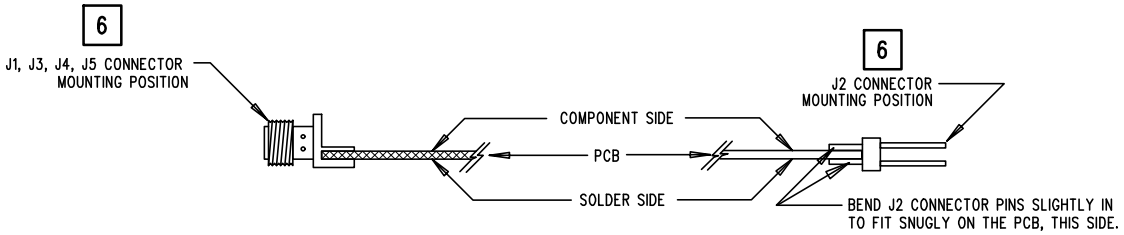
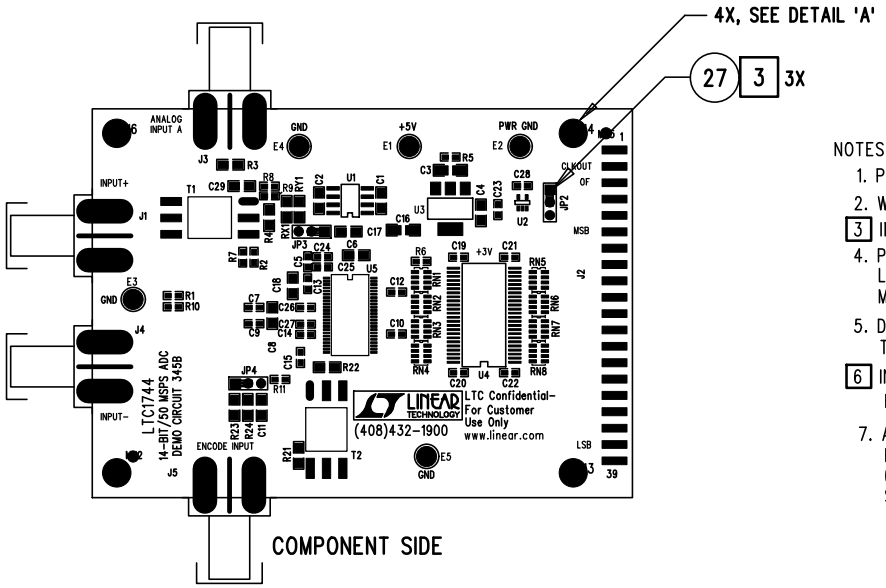


DETAIL–'B'
SCALE: NONE

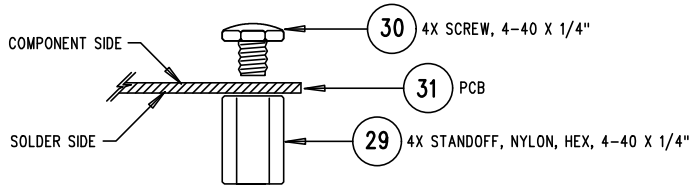


L1–COMPONENT SIDE SILKSCREEN TOP

5

NOTES: UNLESS OTHERWISE SPECIFIED

1. PARTS LIST: SEE BOM DC345B
2. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC–A–610.
3. INSTALL SHUNT, ITEM 27, ON JP2, JP3, JP4 PIN 1 & 2.
4. PARTS TO OMIT WILL BE SPECIFIED ON THE BILLS OF MATERIAL. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
5. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE–OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
6. INSERT 40 PIN CONNECTOR HEARDER (J2) AND SMA CONNECTORS (J1, J3–J5) FLUSH AGAINST BOARD EDGE.
7. ASSY PROCESSES SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD. HAND SOLDER OF J2 CONNECTOR ON ONE SIDE OF THE COMPONENT SIDE (TOP SIDE) AND ONE SIDE ON THE SOLDER SIDE (BOTTOM SIDE). SEE DETAIL 'B'.



DETAIL–'A'
SCALE: NONE